# Technical Summary

# 8-Bit EPROM Microcontroller Unit

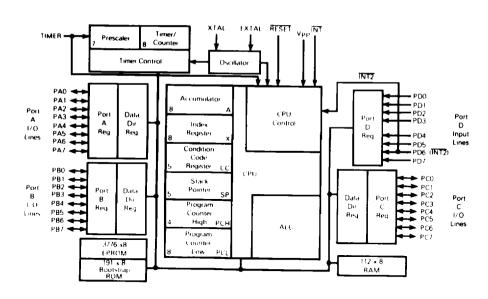
The MC68705U3 (HMOS) Microcontroller Unit (MCU) is an EPROM member of the MC6805 Family of microcontrollers. The user programmable EPROM allows program changes and lower volume applications. This low cost MCU has parallel I O capability with pins programmable as input or output. This publication contains condensed information on the MCU; for detailed information, refer to M6805 HMOS, M146805 CMOS Family User's Manual (M6805UM(AD2)) or contact your local Motorola sales office

Refer to the block diagram for the hardware features and to the list below for additional features available on the MCU.

- Internal 8-Bit Timer with 7-Bit Programmable Prescaler
- On-chip Oscillator
- Memory Mapped LO
- Versatile Interrupt Handling
- Bit Manipulation

- Bit Test and Branch Instruction
- Vectored Interrupts
- Bootstrap Program in ROM
- 112 Bytes of RAM
- 3776 Bytes of EPROM
- 24 I O Pins

## **BLOCK DIAGRAM**



This document contains information on a new product. Specifications and information herein are subject to change without notice

# SIGNAL DESCRIPTION

# VCC AND VSS

Power is supplied to the microcontroller using these two pins. VCC is  $\pm$  5.25 volts ( $\pm$  0.5 $\Delta$ ) power, and VSS is around.

## Vpp

This pin is used when programming the EPROM. In normal operation, this pin is connected to VCC.

#### INT

This pin provides the capability for asynchronously applying on external interrupt to the MCU. Refer to INTER-**RUPTS** for more detailed information

## **EXTAL. XTAL**

These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor capacitor combination, or an external signal (depending on mask option register setting) is connected to these pins to provide a system clock.

## RC Oscillator

With this option, a resistor is connected to the oscillator pins as shown in Figure 1. The relationship between R and fosc is shown in Figure 2.

#### Crystal

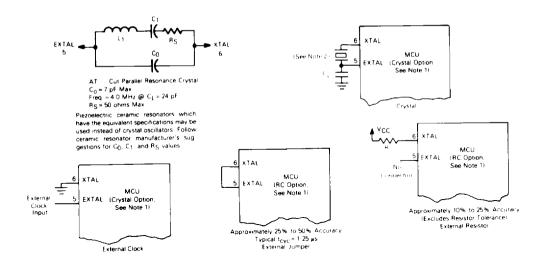
The circuit shown in Figure 1 is recommended when using a crystal. The crystal and components should be mounted as close as possible to the input pins to minimize output distortion and startup stabilization time. Refer to ELECTRICAL SPECIFICATIONS for Voc specifications.

# External Clock

An external clock should be applied to the EXTAL input with the XTAL input connected to VSS, as shown in Figure 1. This option may only be used with the crystal oscillator option selected in the mask option register.

#### TIMER

This pin is used as an external input to control the internal timer/counter circuitry. This pin also detects a



## NOTES:

- 1. For the MC68705U3 MOR b7 0 for the crystal option and MOR b7 1 for the RC option. When the TIMER input pin is in the VIHTP range (in the bootstrap EPROM programming mode), the crystal option is forced. When the TIMER input is at or below VCC, the clock generator option is determined by bit 7 of the mask option register (CLK).
- 2. The recommended CL value with a 4.0 MHz crystal is 27 pF maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the motional arm parameters of the crystal used.

Figure 1. Oscillator Connections

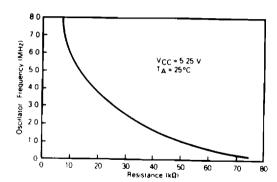


Figure 2. Typical Frequency vs Resistance for RC Oscillator Option Only

higher voltage level used to initiate the bootstrap program.

## RESET

This pin has a Schmitt trigger input and an on-chip pullup. The MCU can be reset by pulling RESET low.

# INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7)

These 32 lines are arranged into four 8-bit ports (A, B, C, and D). Ports A, B, and C are programmable as either inputs or outputs under software control of the data direction registers. Port D is a fixed input port. Port D bit 6 may be used for a second interrupt (INT2). Refer to PROGRAMMING for additional information.

# **PROGRAMMING**

# INPUT/OUTPUT PROGRAMMING

Port A, B, and C pins are programmable as either input or output under software control of the corresponding

data direction register (DDR). Port D is input only. The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic one for output and a logic zero for input. On reset, all the DDRs are initialized to a logic zero state to put the ports in the input mode. The port output registers are not initialized on reset and should be written to before setting the DDR bits.

When programmed as outputs, the latched output data is readable as input data regardless of the logic levels at the output pin due to output loading. The latched output data bit may always be written. Therefore, any write to a port writes all of its data bits, even though the port DDR is set to input. This port write may be used to initialize the data registers and avoid undefined outputs. Care must be exercised when using read-modify-write instructions since the data read corresponds to the pin level if the DDR is an input (zero) and, also, corresponds to the latched output when the DDR is an output (one). Refer to Table 1 for I/O functions and to Figure 3 for typical port circuitry.

## NOTE

Read-modify-write instructions should not be used when writing to the DDRs, because DDRs always read as 'one'.

Table 1. I/O Pin Functions

Data Direction Register Bit	Latched Output Deta Bit	Output State	Input To MCU
1	0	0	
1	1	1 1	1
0	X	Hi-Z**	Pin

\*\*Ports B and C are three-state ports. Port A has an internal pullup devices to provide CMOS data drive capability.

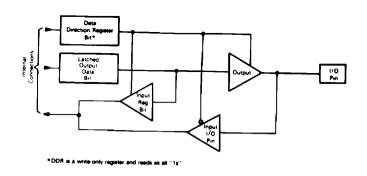


Figure 3. Typical Port I/O Circuitry and Register Configuration

## **MEMORY**

The MCU is capable of addressing 4096 bytes of memory and I/O registers. The memory map is shown in Figure 4. The locations consist of user EPROM, bootstrap ROM, user RAM, a mask option register (MOR), a program control register, and I/O. The interrupt vectors are located from \$FF8 to \$FFF. The bootstrap is a mask-programmed ROM that allows the MCU to program its own EPROM.

The stack area is used during processing of an interrupt or subroutine call to save the CPU state. The stack pointer decrements during pushes and increments during pulls. Refer to INTERRUPTS for additional information.

## NOTE

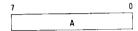
Using the stack area for data storage or temporary work locations requires care to prevent it from being overwritten due to stacking from an interrupt or subroutine call

## REGISTERS

The MCU contains the registers described in the following paragraphs.

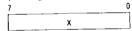
#### **ACCUMULATOR (A)**

The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.



## INDEX REGISTER (X)

The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an 8- or 16- bit immediate value to create an effective address. The index register may also be used as a temporary storage area.



# PROGRAM COUNTER (PC)

The program counter is a 12-bit register that contains the address of the next byte to be fetched.

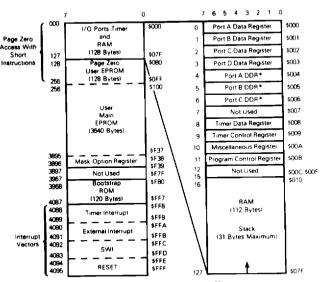


#### STACK POINTER (SP)

The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set at location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is pulled from the stack.

The seven most-significant bits of the stack pointer are permanently set at 0000011. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed).

11		5 4	0
0 0	0 0	1 1	SP



<sup>\*</sup>Caution Data direction registers (DDRs) are write-only, they read as \$FF

Figure 4. Memory Map

# 3

# CONDITION CODE REGISTER (CC)

The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program, and specific actions can be taken as a result of their state. Each bit is explained in the following paragraphs.



# Half Carry (H)

This bit is set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

#### Interrupt (I)

When this bit is set, the timer and external interrupt is masked (disabled). If an external interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

#### Negative (N)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logic 1).

## Zero (Z)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

#### Carry/Borrow (C)

When set, this bit indicates that a carry or borrow out of the arithmetic logical unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions, and during shifts and rotates.

## RESETS

The MCU can be reset two ways: by initial power-up and by the external reset input (RESET). The RESET input consists mainly of a Schmitt trigger that senses the line logic level.

## POWER-ON-RESET (POR)

An internal reset is generated on power-up that allows the internal clock generator to stabilize. The power-on reset is used strictly for power turn-on voltatge. A delay of tRHL milliseconds is required before allowing RESET input to go high. Connecting a capacitor to the RESET input (Figure 5) typically provides sufficient delay.

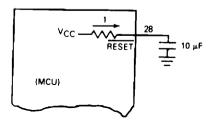


Figure 5. Power-Up RESET Delay Circuit

#### EXTERNAL RESET INPLIT

The MCU is reset when a logic zero is applied to the RESET input for a period longer than one machine cycle (t<sub>Cyc</sub>). Under this type of reset, the Schmitt trigger switches off at VIRES—to provide an internal reset voltage.

#### INTERRUPTS

The MCU can be interrupted four different ways: (1) through the external interrupt  $\overline{\text{INT}}$  input pin, (2) with the internal timer interrupt request, (3) using the software interrupt instruction (SWI), or (4) the external Port D (INT2) input pin.

Interrupts cause the processor registers to be saved on the stack and the interrupt mask (I bit) set to prevent additional interrupts. The RTI instruction causes the register contents to be recovered from the stack after which normal processing resumes. The stacking order is shown in Figure 6.

Unlike RESET, hardware interrupts do not cause the current instruction execution to be halted but are considered pending until the current instruction is complete.

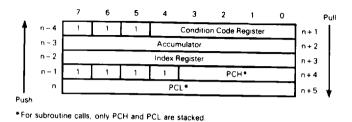


Figure 6. Interrupt Stacking Order

#### NOTE

The current instruction is considered to be the one already fetched and being operated on.

When the current instruction is complete, the processor checks all pending hardward interrupts and, if unmasked (I bit clear), proceeds with interrupt processing; otherwise, the next instruction if fetched and executed. Masked interrupts are latched for later interrupt service. If the timer interrupt status bit is cleared before unmasking the interrupt, then the interrupt is not latched.

If both an external interrupt and a timer interrupt are pending at the end of an instruction execution, the external interrupt is serviced first. The SWI is executed the same as any other instruction regardless of the setting of the I bit. Refer to Figure 7 for the reset and interrupt instruction processing sequence.

# TIMER INTERRUPT

If the time mask bit (TCR6) is cleared, then, each time the timer decrements to zero (transitions from \$01 to \$00), an interrupt request is generated. The actual processor interrupt is generated only if the interrupt mask bit of the

condition code register (CCR) is also cleared. When the interrupt is recognized, the current state of the machine is pushed onto the stack and the I bit in the CCR is set, masking further interrupts until the present one is serviced. The contents of the timer interrupt vector, containing the location of the timer interrupt service routine, is then loaded into the program counter. At the end of the timer interrupt service routine, the software normally executes an RTI instruction which restores the machine state and starts executing the interrupted program. The timer interrupt status bit can only be cleared by software.

#### **EXTERNAL INTERRUPT**

The external interrupt is internally synchronized and then latched on the falling edge of INT and INT2. Clearing the I bit enables the external interrupt. The INT2 interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) in the miscellaneous register (MR). The INT2 interrupt is inhibited when the mask bit is set. The INT2 is always read as a digital input on port D. The INT2 and timer interrupt request bits, if set, cause the MCU to process an interrupt when the condition code I bit is clear. The

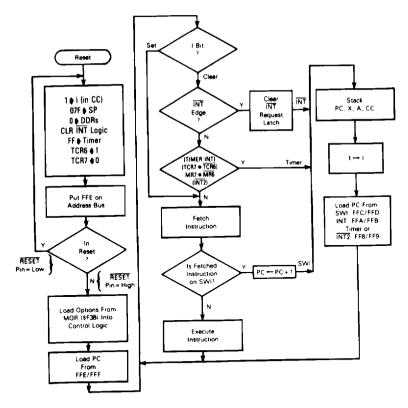


Figure 7. Reset and Interrupt Processing Flowchart

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following paragraphs describe two typical external interrupt circuits.

#### Zero-Crossing Interrupt

A sinusoidal input signal (f<sub>INT</sub> maximum) can be used to generate an external interrupt (see Figure 8a) for use as a zero-crossing detector (for negative transitions of the ac sinusoid). This type of circuit allows applications such as servicing time-of-day routines and engaging/disengaging ac power control devices. Off-chip, full-wave rectification provides an interrupt at every zero crossing of the ac signal and, thereby, provides a 2f clock.

# Digital-Signal Interrupt

With this type of circuit (Figure 8b), the INT pin can be driven by a digital signal. The maximum frequency of a signal that can be recognized by the TIMER or INT pin logic is dependent on the parameter labeled twL, twh. Refer to **TIMER** for additional information.

## SOFTWARE INTERRUPT (SWI)

The SWI is an executable instruction that is executed regardless of the state of the I bit in the CCR. The SWI execution is similar to the hardware interrupts.

### MODES OF OPERATION

The MCU has two modes of operations: normal and bootstrap. The following paragraphs describe these modes

# NORMAL MODE

This mode is a single-chip mode and is entered if the following conditions are met: (1) the RESET line is low, (2) the PCO pin is within its normal operational range, and (3) the Vpp pin is connected to VSS. The next rising edge of the RESET pin then causes the part to enter the normal mode.

## BOOTSTRAP

The bootstrap mode is entered if the TIMER pin is equal to  $\pm$  12 V. For more information refer to application note,

MC68705P3/R3/U3 8-Bit EPROM Microcomputer Programming Module (AN-857/D Rev. 2).

#### TIMER

The MCU consists of an 8-bit software programmable counter driven by a 7-bit software programmable prescaler. The various timer sources are made via the timer control register (TCR) and/or the mask option register (MOR). The 8-bit counter may be loaded under program control and is decremented toward zero. When the timer reaches zero, the timer interrupt request bit (bit 7) in the timer control register (TCR) is set. Refer to Figure 9 for timer block diagram.

The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. When the I bit in the condition code register is cleared and the TCR bit 6 is cleared, the processor receives the interrupt. The MCU responds to this interrupt by (1) saving the present CPU state on the stack, (2) fetching the timer interrupt vector, and (3) executing the interrupt routine. The timer interrupt request bit must be cleared by software. Refer to RESETS and INTERRUPTS for additional information.

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer. To avoid truncation errors, the prescaler is cleared when TCR bit 3 is set to a logic one; however, the TCR bit 3 always reads as a logic zero to ensure proper operation with read-modify-write instructions.

The timer continues to count past zero, falling from \$00 through \$FF, and continues the countdown. The counter can be read at any time by reading the timer data register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred without disturbing the counting process. The TDR is unaffected by reset.

# SOFTWARE CONTROLLED MODE

This mode is selected when TOPT (bit 6) in the MOR is programmed to zero. The timer prescaler input can be configured for three different operating modes plus a disable mode, depending on the value written to TCR control bits 4 and 5 (TIE and TIN). The following paragraphs describe the different modes.

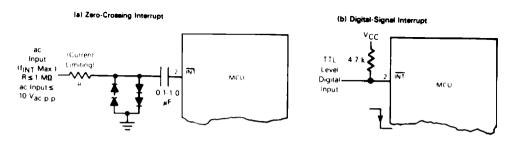
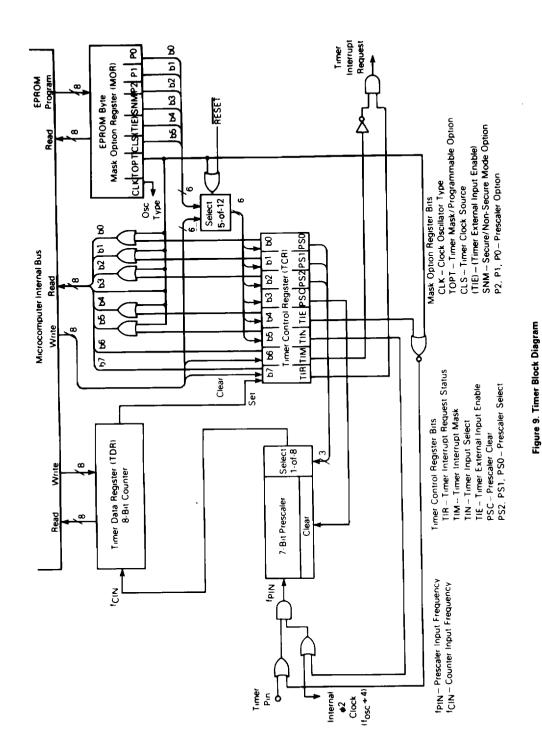


Figure 8. Typical Interrupt Circuits



MOTOROLA MICROPROCESSOR DATA

## Timer Input Mode 1

When TIE and TIN are both programmed to zero, the timer input is from the internal clock (phase two) and the timer input pin is disabled. The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement.

# Timer Input Mode 2

When TIE = 1 and TIN = 0, the internal clock and the timer input signals are ANDed to form the timer input. This mode can be used to measure external pulse widths. The active high, external pulse gates in the internal clock for the duration of the external pulse. The accuracy of the count is  $\pm$  1.

# Timer Input Mode 3

When TIE = 0 and TIN = 1, no prescaler input frequency is applied to the prescaler and the timer is disabled.

## Timer Input Mode 4

When TIE and TIN are both one, the timer input is from the external clock. The external clock can be used to count external events as well as to provide an external frequency for generating periodic interrupts. Frequency of external input must be  $\leq f_{OSC}/8$ .

# MOR CONTROLLED MODE

This mode is selected when TOPT (bit 6) in the MOR is programmed to logic one. The timer circuits are the same as described in **SOFTWARE CONTROLLED MODE**. The logic levels of TCR bits 0, 1, 2, and 5 are determined during EPROM programming by the same bits in the MOR. Therefore, bits 0, 1, 2, and 5 in the MOR control the prescaler division and the timer clock selection. TIE (bit 4) and PSC (bit 3) in the TCR are set to a logic one when in the MOR controlled mode. TIM (bit 6) and TIR (bit 7) are controlled by the counter and software.

## TIMER CONTROL REGISTER (TCR) \$009

This is an 8-bit register that controls various functions such as configuring operation mode, setting ratio of the prescaler, and generating timer interrupt request signal. All bits are read/write except bit 3. The configuration of the TCR is determined by the TOPT (bit 6) in the MOR. When TOPT = 1, the TCR emulates the MC6805U2; when TOPT = 0, the TCR is controlled by software.

7	6	5	4	3	2	1	0
TIR	TIM			PSC		•	

7_	6	5	4	3	2	1	0
TIR	TIM	TIN	TIE	PSC	PS2	PS1	PS0
SET:							
0	1	U	U	ŧı	11	п	11

<sup>\*</sup>The value of corresponding bits in MOR is written during RESET rising edge. These bits always read 'one'.

# TIR — Timer Interrupt Request

Used to indicate the timer interrupt when it is logic one

- 1 = Set when the timer data register changes to all zeros
- 0 Cleared by external reset, power-on reset, or under program control

# TIM — Timer Interrupt Mask

Used to inhibit the timer interrupt

- 1 = Interrupt inhibited
- 0 Interrupt enabled

## TIN - External or Internal

Selects input clock source

- 1 = External clock selected
- 0 = Internal clock selected (fosc/4)

# TIE - TIMER External Enable

Used to enable external TIMER pin. When TOPT = 1, TIE is always a logical "one".

- 1 Enables external timer pin
- 0 = Disables external timer pin

# PSC - Prescaler Clear

Write only bit. Writing a one to this bit resets the prescaler to zero. A read of this location always indicates a zero when TOPT=0. When TOPT=1, this bit will read a logical "one" and has no effect on the prescaler.

# PS2, PS1, PS0 - Prescaler Clear

Decoded to select one of eight outputs of the prescaler

#### Prescaler

PS2	PS1	PS0	Divide By
0	0	0	1
0	0	1	2
0	1	0	4
0	1	1	8
1	0	0	16
1	0	1	32
. 1	1	0	64
1	1	1	128

#### NOTES

When changing the PS bits in software, the PSC bit should be written to a "one" in the same write cycle to clear the prescaler. Changing the PS bits without clearing the prescaler may cause prescaler truncation.

# MASK OPTION REGISTER (MOR) \$F38

The MOR is implemented in EPROM. This register contains all zeros prior to programming and is not affected by reset. The MOR bits are described in the following paragraphs.

7	6	5	4	3	2	1	0
CLK	TOPT	CLS			P2	P1	PO

CLK - Clock (oscillator type)

- 1 = Resistor Capacitor (RC)
- 0 = Crystal

#### TOPT — Timer Option

- 1 = MC6805U2 type timer/prescaler. All bits except 6 and 7, of the TCR are invisible to the user. Bits 5, 2, 1, and 0 of the MOR determine the equivalent MC6805U2 mask options.
- 0 = All TCR bits are implemented as a software programmable timer. The state of MOR bits 5, 4, 2, 1, and 0 sets the initial values of their respective TCR bits.
- CLS Timer/Prescaler Clock Source
  - 1 = External TIMER pin
  - 0 = Internal clock

Bit 4

Not used if TOPT = 1. Sets the initial value of TIE in the TCR if TOPT = 0.

- 1 = Not used
- 0 = Sets initial value of TIE in the TCR
- Bit 3

Not used

P2. P1. P0

The logical levels of these bits, when decoded, select one of eight outputs on the timer prescaler.

n		•	1

P2	P1	P0	Divide By
0	0	0	11
0	0	1	2
0	1	0	4
0	1	1	8
1	0	0	16
1	0	1	32
1	1	0	64
1	1	1	128

# PROGRAMMING CONTROL REGISTER (PCR) \$00B

The PCR is an 8-bit register which provides the necessary control bits to program the EPROM. The bootstrap program manipulates the PCR when programming so the user need not be concerned with PCR in most applications.

7	6	5	4	3	2	1	0
1	1	1	1	1	VPON	PGE	PLE
RESET:	U	υ	U	U	U	1	1

PLE -- Programming Latch Enable

Controls address and data being latched into the EPROM. Set during reset, but may be cleared anytime.

- 1 = Read EPROM
- \_\_\_\_ 0 = Latch address and data on EPROM

PGE - Program Enable

Enables programming of EPROM. Must be set when changing the address and data. Set during reset.

- 1 = Inhibit EPROM programming
- 0 = Enable EPROM programming (if PLE is low)

A read-only bit that indicates high voltage at the Vpp pin. When set to "one", disconnects PGE and PLE from the chip.

- 1 = No high voltage on Vpp pin
- 0 = High voltage on VPP pin

#### NOTE

VPON being "zero" does not indicate that the Vpp level is correct for programming. It is used as a safety interlock for the user in the normal operating mode.

VPON	PGE	PLE	Programming Conditions
0	0	0	Programming mode (program EPROM byte)
1	0	0	PGE and PLE disabled from system
0	1	0	Programming disabled (latch address and data in EPROM)
1	1	0	PGE and PLE disabled from system
0	0	1	Invalid state; PGE = 0 if PLE = 0
1	0	1	Invalid state; PGE - 0 if PLE - 0
0	1	1	"High voltage" on Vpp
1	1	1	PGE and PLE disabled from system (operating mode)

#### **FPROM PROGRAMMING**

## **ERASING THE EPROM**

The EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of 2537 angstroms. The recommended integrated dose (UV intensity × exposure time) is 25Ws/cm². The lamps should be used without software filters, and the MCU should be positioned about one inch from the UV tubes. Ultraviolet erasure clears all bits of the MCU EPROM to the "zero" state. Data then can be entered by programming "ones" into the desired bit locations.

#### **PROGRAMMING**

The MCU bootstrap program can be used to program the MCU EPROM. The alternate vectoring used to implement the self check is used to start execution of the bootstrap program.

A MCM2532 UV EPROM (other industry standard EPROMs may be used) must first be programmed with the same information that is to be transferred to the MCU EPROM. Refer to application note, MC68705P3/R3/U3 8-bit EPROM Microcomputer Programming Module (AN-857/D Rev.2) for schematic diagrams and instructions on programming the MCU EPROM.

# **EMULATION**

The MC68705U3 emulates the MC6805U2 and MC6805U3 "exactly". The MC6805U2 and MC6805U3 mask features are implemented in the mask option register EPROM byte. The following identify the few minor exceptions to the exactness of the emulation.

The MC6805U2 "future ROM" areas are implemented in the MC68705U3 and these 1728 bytes

- must be left unprogrammed to accurately simulate the MC6805U2
- The reserved ROM areas have different data stored in them. In the MC6805U2 this area is used for self check, and in the MC68705U3 this area is used for the bootstrap program.
- The MC6805U2 reads all ones in the 48 byte "future RAM" area. This area is not implemented on the MC6805U2/U3 mask ROM version but is implemented on the MC68705U3.
- The MC68705U3 Vpp (pin 7) line is tied to V<sub>CC</sub> during normal operations. On MC6805U2, this pin is grounded during normal operations, and on the MC6805U3, this pin is not connected.

# INSTRUCTION SET

The MCU has a set of 59 basic instructions which can be divided into five different types: register/memory, read-modify-write, branch, bit manipulation, and control. The following paragraphs briefly explain each type.

# REGISTER/MEMORY INSTRUCTIONS

Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to the following instruction listing.

Function	Mnemonic
Load A from Memory	LDA
Load X from Memory	LDX
Store A in Memory	STA
Store X in Memory	STX
Add Memory to A	ADD
Add Memory and Carry to A	ADC
Subtract Memory	SUB
Subtract Memory from A with Borrow	SBC
AND Memory to A	AND
OR Memory with A	ORA
Exclusive OR Memory with A	EOR
Arithmetic Compare A with Memory	CMP
Arithmetic Compare X with Memory	CPX
Bit Test Memory with A (Logical Compare)	BIT
Jump Unconditional	JMP
Jump to Subroutine	JSR

# **READ-MODIFY-WRITE INSTRUCTIONS**

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to the

read-modify-write sequence since it does not modify the value. Refer to the following list of instructions.

Function	Mnemonic
Increment	INC
Decrement	DEC
Clear	CLR
Complement	СОМ
Negate (2's Complement)	NEG
Rotate Left Thru Carry	ROL
Rotate Right Thru Carry	ROR
Logical Shift Left	LSL
Logical Shift Right	LSR
Arithmetic Shift Right	ASR
Test for Negative or Zero	TST

# **BRANCH INSTRUCTIONS**

This set of instructions branches if a particular condition is met; otherwise, no operation is performed. Branch instructions are two-byte instructions. Refer to the following list for branch instructions.

Function	Mnemonic
Branch Always	BRA
Branch Never	BRN
Branch if Higher	ВНІ
Branch if Lower or Same	BLS
Branch if Carry Clear	BCC
(Branch if Higher or Same)	(BHS)
Branch if Carry Set	BCS
(Branch if Lower)	(BLO)
Branch if Not Equal	BNE
Branch if Equal	BEQ
Branch if Half Carry Clear	внсс
Branch if Half Carry Set	BHCS
Branch if Plus	BPL
Branch if Minus	BMI
Branch if Interrupt Mask Bit is Clear	ВМС
Branch if Interrupt Mask Bit is Set	BMS
Branch if Interrupt Line is Low	BIL
Branch if Interrupt Line is High	ВІН
Branch to Subroutine	BSR

# **BIT MANIPULATION INSTRUCTIONS**

The MCU is capable of setting or clearing any bit which resides in the first 256 bytes of the memory space where all port registers, port DDRs, timer, timer control, and on-chip RAM reside. An additional feature allows the software to test and branch on the state of any bit within

these 256 locations. The bit set, bit clear and bit test, and branch functions are all implemented with a single instruction. For test and branch instructions, the value of the bit tested is also placed in the carry bit of the condition code register. Refer to the following list for bit manipulation instructions.

Function	Mnemonic
Branch if Bit n is Set	BRSET n (n = 0 7)
Branch if Bit n is Clear	BRCLR n (n = 0 7)
Set Bit n	BSET n (n = 0 7)
Clear Bit n	BCLR n (n = 0 7)

## CONTROL INSTRUCTIONS

These instructions are register reference instructions and are used to control processor operation during program execution. Refer to the following list for control instructions.

Function	Mnemonic
Transfer A to X	TAX
Transfer X to A	TXA
Set Carry Bit	SEC
Clear Carry Bit	CLC
Set Interrupt Mask Bit	SEI
Clear Interrupt Mask Bit	CLI
Software Interrupt	SWI
Return from Subroutine	RTS
Return from Interrupt	RTI
Reset Stack Pointer	RSP
No-Operation	NOP

# **OPCODE MAP SUMMARY**

Table 3 is an opcode map for the instructions used on the MCU.

## ADDRESSING MODES

The MCU uses ten different addressing modes to provide the programmer with an opportunity to optimize the code for all situations. The various indexed addressing modes make it possible to locate data tables, code conversion tables, and scaling tables anywhere in the memory space. Short indexed accesses are single-byte instructions, while the longest instructions (three bytes) permit accessing tables throughout memory. Short and long absolute addressing is also included. Two-byte direct-addressing instructions access all data bytes in most applications. Extended addressing permits jump instructions to reach all memory.

The term "effective address" (EA) is used in describing the various addressing modes. Effective address is defined as the address from which the argument for an instruction is fetched or stored.

#### IMMEDIATE

In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants that do not change during program execution (e.g., a constant used to initialize a loop counter).

#### DIRECT

In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two-byte instruction.

#### **EXTENDED**

In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode byte. Instructions with extended addressing mode are capable of referencing arguments anywhere in memory with a single three-byte instruction.

#### RELATIVE

The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte (the offset) following the opcode is added to the PC if, and only if, the branch conditions are true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from - 126 to + 129 from the opcode address.

#### INDEXED, NO OFFSET

In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

# INDEXED, 8-BIT OFFSET

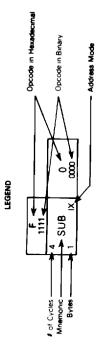
In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. The addressing mode is useful for selecting the Kth element in an n element table. With this two-byte instruction, K would typically be in X with the address of the beginning of the table in the instruction. As such, tables may begin anywhere within the first 256 addressable locations and could extend as far as location 510 (\$1FE is the last location at which the instruction may begin).

# INDEXED, 16-BIT OFFSET

In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a maner similar to indexed, 8-bit offset except that this three-byte instruction allows tables to be anywhere in memory.

Table 3. Opcode Map

	Ĭ	COMPONE	Branch			Read-Modify-Write	Vrite		S	Commo							
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/	-[	- [	7	m	•	0	•	-		5		5		2	×	×	
		1		Ē	g S	1000	0110	1110	9001	100	ě	n Ş	ٍو ب	ؤ م	<u>.</u>	<u>.</u>	\ *
000	BASETO 3 BIB	BSET0	BRA 2 RE	NEG	, REG	NEG	NEG	, NEG	P ITR		SUB	SUB	Sus.	9 J	9		
_	10 BBCI BO	78	8	L			*	-	I		NA.	Diff	, ž	300	1X1	306	-8
á	3.0	*	A PER						PTS.	-	CMP	CMP	CMP	CMP	CMP	CMP	1
2 0010	BASET1	BSET1 2 BSC	9Hi 2 BHi								SBC	SBC	ZBC SBC	2x 287	× S	× Vau	100
۳į	BRCLAI	BCLR1	8LS	• • •	COMA	XWOO	20	]     			MM	Diff		X X	2 30° 5	A T	,ã
		Se se	7	-	r.	- •		, , , , , , , , , , , , , , , , , , ,	3,4		WW.	CPX 2 2	CPX 5.XT	3 CPX	CPX X	CPX C	٣ê
0000	3 BTB	SSE 12	2 BCC	LSA P'A	LSRA	LSAX	LSP	LSR			AND	AND	AND	AND	AND	AND	
S [0	BRCLR2	BCLR2 2 BSC	BCS 2 REL								Bir	118	Ē	, Lia	¥ Lia	× -	99 4
<b>9</b> 00	BASET3	BSET3 2 BSC	BNE	6 AOR	RORA	RORX	F0F	HOH.			LDA	PIG V	EX.	Z & C	× 4	ă d	ioto
0111	BRCLR3	BCLR3	, <b>BE</b> 0	ASR	ASBA	ASRX	ASR	e ASP	Ť	TAX	NA.	AT S		-L	4	¥ .	9.50
80 5	BASETA	BSET4	BHCC	181	LSLA	× ISI	× Z	× آن العا		Ī		E A	-	-4	Y X	STA	1110
,	20.00			PIO 9	Į.	Ĭ	.x		-7	H.	WW.	FOR	EOR Ext	3 FOR	- EOH	EON	æ §
·įβ		SCL S	T T	ROL PiR	HOLA INH	ROLX	POL.	, ROL	· -	SEC	ADC	ADC	ADC	ADC.	y ADC	y ADC	68
<b>V</b> ioi	BASETS 3 BTB	BSET5 2	2 BPL	DEC	DECA	DECX	. DEC	. Dec		3		OBA PRO	8	NA NA	× V	ž	8
1,01	BACLAS 3 BTB	BCLR5	BMI							SE	ADD	ADD		ZX CV	× 4	ž (	, go
وں	BASETE	BSETE	BMC	υ N	INCA	INCX	INC -	<u> </u>	-	I O	MN	al G	1	2 X	ž Ž	×	Φģ
۵	BRCLRG	P	BMS	F 27	THE STATE OF THE S		×		- +	I Z		HO I	EX.	3 INP	AMP ×	JMP X	ပဋ
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, i	8	358 4 388 4	2 BILL	,		- f					LDX	E COX	רסא נאו	LDX,	rox.	χĠ	<b>.</b>
_	3 BTB	BCLR7	2 BIH	CLR OHB	CLRA	CLRX INH	: آنه الهان	C. 1.	-	××	<u> </u>	STX	STX	×TZ	STX	STX.	2 4
					!			1		-	Ì	H O	EXT	3 ×2	- ×	×	=



INH Inherent
IMM immediate
DIR Direct
EXT Extended
EXT Relative
BSC Bit Set/Clear
BTB Bit Test and Branch
IX Indexed, 1 Byte (BBit) Offset
IXZ Indexed, 2 Byte (16-Bit) Offset

# MC68705113

# BIT SET/CLEAR

In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode. The byte following the opcode specifies the direct addressing of the byte to which the specified bit is to be set or cleared. Thus, any read/ write bit in the first 256 locations of memory, including 1/O, can be selectively set or cleared with a single twobyte instruction.

## **BIT TEST AND BRANCH**

The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit to be tested, and its condition (set or clear), is included in the opcode. The address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset in the third byte is added to the PC if the specified bit is set or cleared in the specified memory location. This single three-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from - 125 to + 130 from the opcode address. The state of the tested bit is also transferred to the carry bit of the condition code register.

# INHERENT

In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator as well as the control instruction with no other arguments are included in this mode. These instructions are one byte long.

#### **FLECTRICAL SPECIFICATIONS**

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	Vcc	- 0.3 to +7.0	٧
Input Voltage EPROM Programming Voltage (Vpp Pin) TIMER Pin — Normal Mode TIMER Pin — Bootstrap Programming Mode All Others	VPP Vin Vin Vin	- 0.3 to + 22.0 - 0.3 to + 7.0 - 0.3 to + 15.0 - 0.3 to + 7.0	V
Operating Temperature Range MC68705U3 MC68705U3C	TA	T <sub>L</sub> to T <sub>H</sub> 0 to +70 -40 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	- 55 to + 150	°C
Junction Temperature Cerdip	Tj	175	°C/W

These devices contain circuity to protect the inputs against damage due to high static voltages or electrical fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, it is recommended that Vin and Vout be constrained to the range VSS≤(Vin and Vout)≤VCC. Reliability of operation is enhanced if unused inputs except EXTAL are tied to an appropriate logic voltage level (e.g., either VSS or Vcc).

# THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance Cerdip	ΑLθ	60	°C/W

## **POWER CONSIDERATIONS**

The average chip-junction temperature, T<sub>J</sub>, in °C can be obtained from:

$$T_{,i} = T_{A} + (P_{D} \cdot \theta_{,iA}) \tag{1}$$

where:

 $T_{A}$ θJA = Ambient Temperature, °C = Package Thermal Resistance,

 $P_{\mathsf{D}}$ 

Junction-to-Ambient, °C/W

PINT

 $= P_{INT} + P_{PORT}$   $= I_{CC} \times V_{CC}, Watts - Chip Internal Power$ 

PPORT

= Port Power Dissipation,

Watts - User Determined

For most applications PPORT<PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between PD and T1 (if P<sub>PORT</sub> is neglected) is:

$$P_D = K \div (T_J + 273^{\circ}C)$$
 (2)

Solving equations (1) and (2) for K gives:

 $K = P_D \cdot (T_A + 273^{\circ}C) + \theta JA \cdot PD^2$ 

where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring PD (at equilibrium) for a known TA. Using this value of K, the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA

# PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS

(VDD = 5.25 Vdc ± 0.5%, VSS = 0 Vdc, TA = 20 to 30°C, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Programming Voltage	Vpp	20.0	21.0	22.0	v
Vpp Supply Current Vpp = 5.25 V Vpp = 21.0 V	Ірр	=		8 30	mA
Programming Oscillator Frequency	foscp	0.9	1.0	1,1	MHz
Bootstrap Programming Mode Voltage (TIMER Pin) α I <sub>IHTP</sub> = 100 μA Maximum	VIHTP	9.0	12.0	15.0	٧

# **ELECTRICAL CHARACTERISTICS**

(VCC + 5.25 Vdc + 0.5 Vdc, VSS = 0 Vdc, TA = 0°C to 70°C, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Input High Voltage   RESET (4.99 < V <sub>CC</sub> < 5.51)	VIH	4.0 V <sub>CC</sub> - 0.5 4.0 V <sub>CC</sub> - 0.5 2.0	- - ** -	Vcc Vcc Vcc Vcc Vcc	٧
Input High Voltage (TIMER Pin) Timer Mode Bootstrap Programming Mode	V <sub>IH</sub>	2.0 9.0	12.0	V <sub>CC</sub> + 1.0 15.0	V
Input Low Voltage RESET INT All Other	V <sub>IL</sub>	Vss Vss Vss	-	0.8 1.5 0.8	٧
Internal Power Dissipation (No Port Loading, $V_{CC}$ = 5.25 V $T_A$ = 0°C for Steady-State Operation) $T_A$ = $-40$ °C	PINT	_	520 580	740 800	mW
Input Capacitance EXTAL All Other	C <sub>in</sub>		25 10	_	pF
INT Zero-Crossing Input Voltage — Through a Capacitor	VINT	2.0	_	4.0	V <sub>ac p-p</sub>
RESET Hysteresis Voltage Out of Reset Voltage Into Reset Voltage	VIRES +	2.1 0.8		4.0 2.0	V
Programming Voltage (Vpp Pin) Programming EPROM Operating Mode	V <sub>PP</sub> *	20.0 4.75	21.0 VCC	22.0 5.75	V
Input Current  TIMER (V <sub>in</sub> = 0.4 V)  INT (V <sub>in</sub> = 0.4 V)  EXTAL (V <sub>in</sub> = 2.4 V to V <sub>CC</sub> Crystal Option)  (V <sub>in</sub> = 0.4 V Crystal Option)  RESET (V <sub>in</sub> = 0.8 V)  (External Capacitor Changing Current)	lin IRES	   	20  	20 50 10 - 1600 - 40	μΑ

 $<sup>^{4}</sup>$ Vpp (pin 7) is connected to V<sub>CC</sub> in the normal operating mode.  $^{**}$ Due to internal biasing, this input (when not used) floats to approximately 2.0 V.

# SWITCHING CHARACTERISTICS

 $(V_{CC} = +5.25 \text{ Vdc } \pm 0.5 \text{ V}, V_{SS} = 0 \text{ Vdc}, T_A = 0^{\circ}\text{C to } 70^{\circ}\text{C}, \text{ unless otherwise noted})$ 

Characteristic	Symbol	Min	Тур	Max	Unit
Oscillator Frequency Normal	fosc	0.4		4.2	MHz
Instruction Cycle Time (4/f <sub>OSC</sub> )	t <sub>cyc</sub>	0.950		10	μs
INT, INT2, or Timer Pulse Width	tWL, tWH	t <sub>cyc</sub> + 250			ns
RESET Pulse Width	tRWL	t <sub>cyc</sub> + 250			ns
RESET Delay Time (External Cap = 1.0 μF)	tRHL	100	<u> </u>		ms
INT Zero Crossing Detection Input Frequency	fINT	0.03		1.0	kHz
External Clock Duty Cycle (EXTAL)		40	50	60	%
Crystal Oscillator Start-Up Time	_	_	_	100	ms

# PORT ELECTRICAL CHARACTERISTICS

(V<sub>CC</sub> = +5.25 Vdc ±0.5 Vdc, V<sub>SS</sub> = 0 Vdc, T<sub>A</sub> = 0° to 70°C, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
	Port A				
Output Low Voltage, ILoad = 1.6 mA	VOL			0.4	V
Output High Voltage, I <sub>Load</sub> = - 100 μA	Voн	2.4			V
Output High Voltage, 1 <sub>Load</sub> = -10 μA	Voн	V <sub>CC</sub> · 1.0			V
Input High Voltage, I <sub>Load</sub> = -300 μA (Max)	VIH	2.0		Vcc	V
input Low Voltage, ILoad = - 500 μA (Max)	VIL	V <sub>SS</sub>		0.8	٧
Hi-Z State Input Current (Vin = 2.0 V to VCC)	Чн			300	μА
Hi-Z State Input Current (Vin = 0.4 V)	1 <sub>1</sub> L	_		- 500	μА
	Port B				
Output Low Voltage, ILoad = 3.2 mA	VOL			0.4	V
Output Low Voltage, ILoad = 10 mA (Sink)	V <sub>OL</sub>			1.0	V
Output High Voltage, I <sub>Load</sub> = -200 μA	Voн	2.4			V
Darlington Current Drive (Source), Vo = 1.5 V	ГОН	1.0		- 10	mA
Input High Voltage	VIH	2.0		V <sub>C</sub> C.	V
Input Low Voltage	V <sub>IL</sub>	VSS		0.8	V
Hi-Z State Input Current	TSI		· <u>2</u>	10	μΑ
	Port C				,
Output Low Voltage, ILoad = 1.6 mA	VOL	_		0.4	V
Output High Voltage, I <sub>Load</sub> = 100 μA	VOH	2.4			V
Input High Voltage	VIH	2.0		VCC	V
Input Low Voltage	VIL	VSS		0.8	V
Hi-Z State Input Current	ITSI	_	٠ 2	10	μΑ
	Port D (Input On	ly)			
Input High Voltage	ViH	2.0		VCC	V
Input Low Voltage	V <sub>1</sub> L	V <sub>SS</sub>		0.8	V
Input Current	lin	_	< 1	5	μΑ

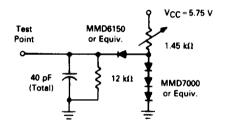


Figure 10. TTL Equivalent Test Load (Port B)

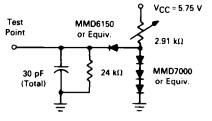


Figure 12. TTL Equivalent Test Load (Ports A and C)

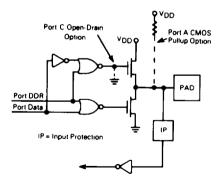


Figure 14. Ports A and C Logic Diagram

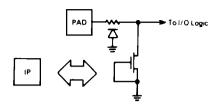


Figure 16. Typical Input Protection

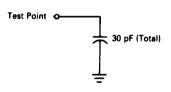


Figure 11. CMOS Equivalent Test Load (Port A)

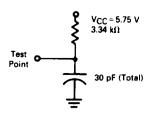


Figure 13. Open-Drain Equivalent Test Load (Port C)

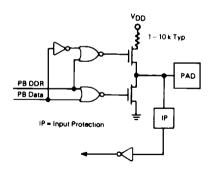


Figure 15. Port B Logic Diagram

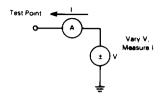


Figure 17. I/O Characteristic Measurement Circuit

# ORDERING INFORMATION

The following table provides generic information pertaining to the package type, temperature, and MC order numbers for the MC68705U3.

Table 3. Generic Information

Package Type	Temperature	Order Number
Cerdip	0° to 70°C	MC68705U3S
S Suffix	40° to +85°C	MC68705U3CS

# MECHANICAL DATA

# PIN ASSIGNMENTS

